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[10191/2251]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s) : SPITZ et al. Confirmation No.: 7205
Serial No. : 10/070,521
Filed : July 8, 2002
For : ARRANGEMENT HAVING P-DOPED AND N-DOPED SEMICONDUCTOR LAYERS, AND METHOD FOR THE MANUFACTURE THEREOF
Examiner : J. Jackson
Art Unit : 2815
Customer No. : 26646

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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Date 3/22/06 Atty's Reg. # 41,172

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DERVIS MAGISTRE
KENYON & KENYON LLP

RESPONSE TRANSMITTAL

SIR:

Please find a Response transmitted herewith for filing in the above-identified patent application.

No fee is believed to be required. However, if any fee is required, please use Deposit Account No. 11-0600. A duplicate copy of this transmittal letter is enclosed for that purpose.

Respectfully submitted,

KENYON & KENYON LLP

Dated: 3/22/06

By: LQ2 (B.N. 41,172)

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Atty's Signature LDZ
DERVIS MAGISTRE
KENYON & KENYON LLP

RESPONSE

SIR:

In response to the Office Action dated February 13, 2006, reconsideration and allowance of the above-referenced application are requested for the reasons below.

Amendments to the Specification do not appear in this paper.

Amendments to the Claims do not appear in this paper.

Amendments to the Drawings do not appear in this paper.

Remarks begin on page 2 of this paper.